# SDIA6010 TYPE

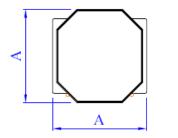
#### **FEATURE**

- 1. Low profile and small size (Height=1.00mm Max)
- 2. Low DC resistance

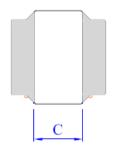
#### Applications

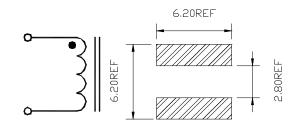
- 1. LCD panels
- 2. Digital camera, PDA and others
- Shape and Dimension

## Schematics and Land Patterns(mm)









A=6.00±0.20m/m; B=1.00m/m MAX; C=2.70m/m TYP.

## Specification

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Part Number	L(uH)	DCR(Ω max)	Isat(A)	Irms(A)
SDIA6010-2R2M	2.2±20%	0.155	2.20	1.90
SDIA6010-3R3M	3.3±20%	0.205	1.90	1.50
SDIA6010-4R7M	4.7±20%	0.277	1.65	1.40
SDIA6010-6R8M	6.8±20%	0.350	1.60	1.22
SDIA6010-8R2M	8.2±20%	0.390	1.20	1.21
SDIA6010-100M	10±20%	0.400	1.40	1.20

Note1. Measurement frequency of Inductance value: at 100KHz

Note2. Measurement ambient temperature of L, DCR and IDC : at  $25^{\circ}$ C

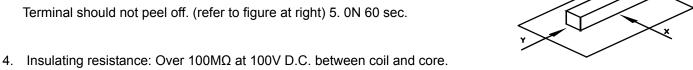
Note3. Isat :  $\triangle L/L \le 30\%$  (This indicates the value of current when the inductances is 20% lower than its initial value at D.C. superimposition)

Note4. Irms:D.C. current when at  $\Delta t=40^{\circ}$ C (typ.).(Ta=25 $^{\circ}$ C)

Note5.Packaging: Taping; Quantity: 1000 Pieces/reel

# GENERAL CHARACTERISTICS

- Operating temperature range: -40 TO + 105<sup>o</sup> (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.



- Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260℃, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: 10°C ~ 35°C (Generally: 21°C ~ 31°C) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%); Transportation condition: Temperature Range: -35°C ~ 85°C , Humidity Range: 50% ~ 95% RH
- 12. Use components within 6 months. If 6 months or more have elapsed, check soldarability before use.
- 13. Reflow profile recommend:

## Lead-free heat endurance test

#### Lead-free the recommended reflow condition

